

积层贴片陶瓷片式电容器

C3216X7R2J153K130AA

RoHS Reach Halogen Free Pb Free

交货型号	C3216X7R2J153KT****
用途	一般等级 车载用途时为 CGA5K4X7R2J153K130AA 。
特点	Mid 中耐压 (100~630V)
系列	C3216 [EIA 1206]
状态	量产体制(新设计非推荐)



尺寸

长度(L)	3.20mm ±0.20mm
宽度(W)	1.60mm ±0.20mm
厚度(T)	1.30mm ±0.20mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	1.00mm Min.
推荐焊盘布局(PA)	2.10mm to 2.50mm(Flow Soldering) 2.00mm to 2.40mm(Reflow Soldering)
推荐焊盘布局(PB)	1.10mm to 1.30mm(Flow Soldering) 1.00mm to 1.20mm(Reflow Soldering)
推荐焊盘布局(PC)	1.00mm to 1.30mm(Flow Soldering) 1.10mm to 1.60mm(Reflow Soldering)

电气特性

电容	15nF ±10%
额定电压	630VDC
温度特性	X7R(±15%)
耗散因数 (Max.)	3%
绝缘电阻 (Min.)	10000MΩ

其他

焊接方法	流体 回流
AEC-Q200	NO
包装形式	塑封编带 (180mm卷筒)
包装个数	2000pcs

! Images are for reference only and show exemplary products.

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Associated Images

